# 54F10,74F10

54F10 Triple 3-Input NAND Gate



Literature Number: SNOS148A



# 54F/74F10 Triple 3-Input NAND Gate

### **General Description**

This device contains three independent gates, each of which performs the logic NAND function.

Commercial	Military	Package Number	Package Description
74F10PC		N14A	14-Lead (0.300" Wide) Molded Dual-In-Line
	54F10DM (Note 2)	J14A	14-Lead Ceramic Dual-In-Line
74F10SC (Note 1)		M14A	14-Lead (0.150" Wide) Molded Small Outline, JEDEC
74F10SJ (Note 1)		M14D	14-Lead (0.300" Wide) Molded Small Outline, EIAJ
	54F10FM (Note 2)	W14B	14-Lead Cerpack
	54F10LM (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C

Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

# Logic Symbol

## **Connection Diagrams**



		54F/74F			
Pin Names	Description	U.L. HIGH/LOW	Input I <sub>IH</sub> /I <sub>IL</sub> Output I <sub>OH</sub> /I <sub>OL</sub>		
A <sub>n</sub> , B <sub>n</sub> , C <sub>n</sub> <del>O</del> n	Inputs Outputs	1.0/1.0 50/33.3	20 µA/−0.6 mA −1 mA/20 mA		

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# Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +175°C
Plastic	-55°C to +150°C
V <sub>CC</sub> Pin Potential to	
Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to $+7.0V$
Input Current (Note 2)	-30 mA to $+5.0$ mA
Voltage Applied to Output	
in HIGH State (with $V_{CC} = 0V$ )	
Standard Output	-0.5V to V <sub>CC</sub>
TRI-STATE <sup>®</sup> Output	-0.5V to $+5.5V$
Current Applied to Output	
in LOW State (Max)	twice the rated IOI (mA)

# Recommended Operating Conditions

# Free Air Ambient Temperature

Military	-55°C to +125°C
Commercial	0°C to +70°C
Supply Voltage	
Military	+4.5V to +5.5V
Commercial	+ 4.5V to + 5.5V

in LOW State (Max) twice the rated I<sub>OL</sub> (mA) Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

# **DC Electrical Characteristics**

Symbol	Parameter		54F/74F			Units	Vcc	Conditions	
oymbol			Min	Тур	Max	onito	•00	Conditions	
V <sub>IH</sub>	Input HIGH Voltage		2.0			V		Recognized as a HIGH Sign	
V <sub>IL</sub>	Input LOW Voltage				0.8	>		Recognized as a LOW Signa	
V <sub>CD</sub>	Input Clamp Diode Vo	oltage			-1.2	V	Min	$I_{IN} = -18 \text{ mA}$	
V <sub>OH</sub>	Output HIGH Voltage	54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub> 74F 5% V <sub>CC</sub>	2.5 2.5 2.7			v	Min	$I_{OH} = -1 \text{ mA}$ $I_{OH} = -1 \text{ mA}$ $I_{OH} = -1 \text{ mA}$	
V <sub>OL</sub>	Output LOW Voltage	54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub>			0.5 0.5	v	Min	$I_{OL} = 20 \text{ mA}$ $I_{OL} = 20 \text{ mA}$	
IIH	Input HIGH Current	54F 74F			20.0 5.0	μΑ	Max	$V_{IN} = 2.7V$	
I <sub>BVI</sub>	Input HIGH Current Breakdown Test	54F 74F			100 7.0	μΑ	Max	V <sub>IN</sub> = 7.0V	
ICEX	Output HIGH Leakage Current	54F 74F			250 50	μΑ	Max	$V_{OUT} = V_{CC}$	
V <sub>ID</sub>	Input Leakage Test	74F	4.75			V	0.0	$I_{ID} = 1.9 \ \mu A$ All other pins grounded	
I <sub>OD</sub>	Output Leakage Circuit Current	74F			3.75	μΑ	0.0	$V_{IOD} = 150 \text{ mV}$ All other pins grounded	
IIL	Input LOW Current				-0.6	mA	Max	$V_{IN} = 0.5V$	
los	Output Short-Circuit C	Current	-60		-150	mA	Max	$V_{OUT} = 0V$	
ICCH	Power Supply Current	t		1.4	2.1	mA	Max	V <sub>O</sub> = HIGH	
ICCL	Power Supply Current	t		5.1	7.7	mA	Max	$V_{O} = LOW$	

AC Electrical Characteristics									
		$\begin{tabular}{lllllllllllllllllllllllllllllllllll$			54F T <sub>A</sub> , V <sub>CC</sub> = Mil C <sub>L</sub> = 50 pF		$74F$ $T_{A}, V_{CC} = Com$ $C_{L} = 50 \text{ pF}$		Units
Symbol	Parameter								
		Min	Тур	Мах	Min	Max	Min	Max	
t <sub>PLH</sub>	Propagation Delay	2.4	3.7	5.0	2.0	7.0	2.4	6.0	ns
t <sub>PHL</sub>	$A_n$ , $B_n$ , $C_n$ to $\overline{O}_n$	1.5	3.2	4.3	1.5	6.5	1.5	5.3	115

# **Ordering Information**

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:









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# 54F/74F10 Triple 3-Input NAND Gate

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